



Description

JMT N-channel Enhancement Mode Power MOSFET

Features

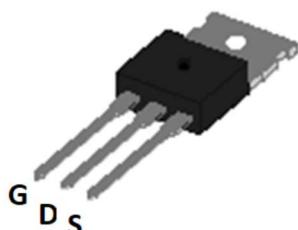
- 60V, 120A
- $R_{DS(ON)} < 6m\Omega$ @ $V_{GS} = 10V$
- Advanced Trench Technology
- Provide Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead free product is acquired

Application

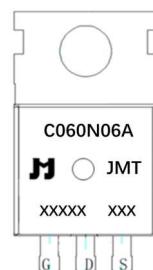
- Load Switch
- PWM Application
- Power management



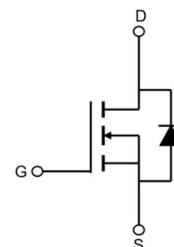
100% UIS TESTED!
100% ΔV_{ds} TESTED!



TO-220C top view



Marking and pin Assignment



Schematic Diagram

Package Marking and Ordering Information

| Device Marking | Device | OUTLINE | Device Package | TUBE (PCS) | Inner Box (PCS) | Per Carton (PCS) |
|----------------|-------------|---------|----------------|------------|-----------------|------------------|
| JMTC060N06A | JMTC060N06A | TUBE | TO-220C | 50 | 1,000 | 5,000 |

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise specified)

| Symbol | Parameter | | Max. | Units |
|-----------------|---|---------------------|-------------|--------------|
| V_{DSS} | Drain-Source Voltage | | 60 | V |
| V_{GSS} | Gate-Source Voltage | | ± 20 | V |
| I_D | Continuous Drain Current | $T_c = 25^\circ C$ | 120 | A |
| | | $T_c = 100^\circ C$ | 78 | A |
| I_{DM} | Pulsed Drain Current ^{note1} | | 480 | A |
| EAS | Single Pulsed Avalanche Energy ^{note2} | | 400 | mJ |
| P_D | Power Dissipation | $T_c = 25^\circ C$ | 181 | W |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | | 0.83 | $^\circ C/W$ |
| T_J, T_{STG} | Operating and Storage Temperature Range | | -55 to +175 | $^\circ C$ |

**Electrical Characteristics** ($T_J=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---|--|---|------|------|-----------|------------------|
| Off Characteristic | | | | | | |
| $V_{(\text{BR})\text{DSS}}$ | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$ | 60 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=60\text{V}$, $V_{GS}=0\text{V}$, | - | - | 1.0 | μA |
| I_{GSS} | Gate to Body Leakage Current | $V_{DS}=0\text{V}$, $V_{GS}=\pm 20\text{V}$ | - | - | ± 100 | nA |
| On Characteristics | | | | | | |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$ | 2 | 3 | 4 | V |
| $R_{DS(\text{on})}$ | Static Drain-Source on-Resistance note3 | $V_{GS}=10\text{V}$, $I_D=30\text{A}$ | - | 4.6 | 6 | $\text{m}\Omega$ |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS}=25\text{V}$, $V_{GS}=0\text{V}$, $f=1.0\text{MHz}$ | - | 5672 | - | pF |
| C_{oss} | Output Capacitance | | - | 392 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 352 | - | pF |
| Q_g | Total Gate Charge | $V_{DS}=30\text{V}$, $I_D=30\text{A}$, $V_{GS}=10\text{V}$ | - | 103 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 15 | - | nC |
| Q_{gd} | Gate-Drain("Miller") Charge | | - | 32 | - | nC |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DS}=30\text{V}$, $I_D=30\text{A}$, $R_G=1.8\Omega$, $V_{GS}=10\text{V}$ | - | 12 | - | ns |
| t_r | Turn-on Rise Time | | - | 8 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 49 | - | ns |
| t_f | Turn-off Fall Time | | - | 15 | - | ns |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_S | Maximum Continuous Drain to Source Diode Forward Current | - | - | 120 | A | |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | 480 | A | |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS}=0\text{V}$, $I_S=30\text{A}$ | - | - | 1.2 | V |
| trr | Body Diode Reverse Recovery Time | $I_F=30\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$ | - | 27 | - | ns |
| Qrr | Body Diode Reverse Recovery Charge | | - | 48 | - | nC |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition : $T_J=25^\circ\text{C}$, $V_{DD}=30\text{V}$, $V_G=10\text{V}$, $L=0.5\text{mH}$, $R_g=25\Omega$, $I_{AS}=40\text{A}$ 3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$

Typical Performance Characteristics

Figure 1: Output Characteristics

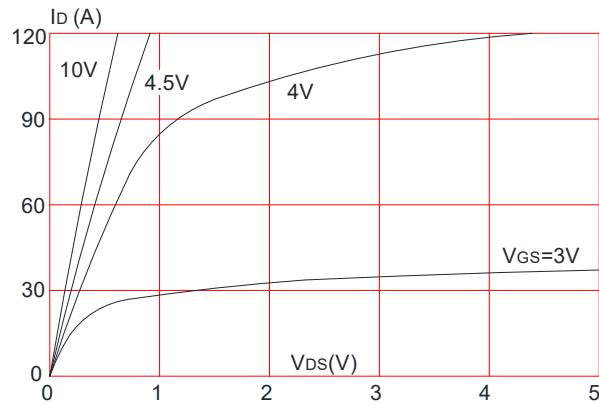


Figure 3: On-resistance vs. Drain Current

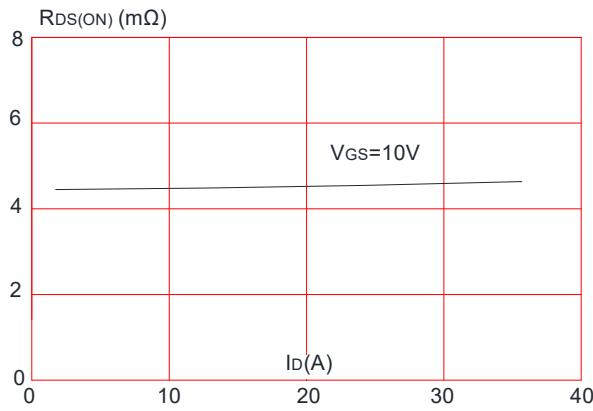


Figure 5: Gate Charge Characteristics

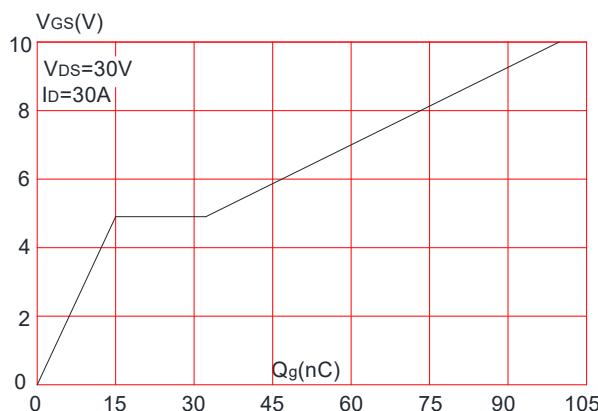


Figure 2: Typical Transfer Characteristics

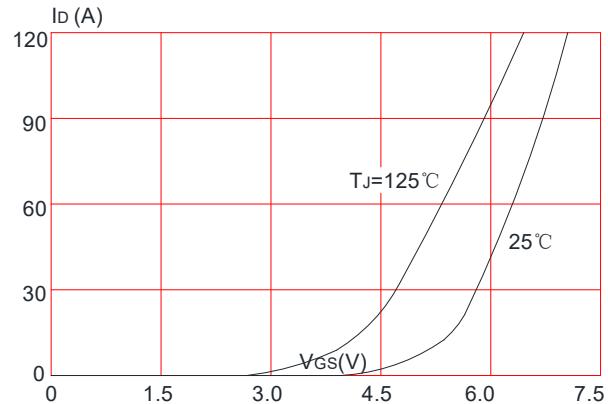


Figure 4: Body Diode Characteristics

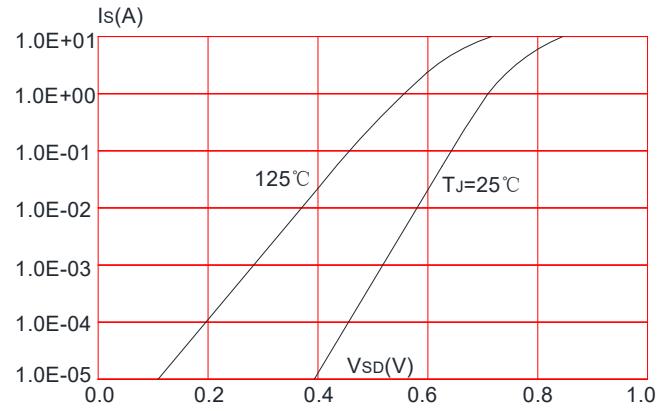


Figure 6: Capacitance Characteristics

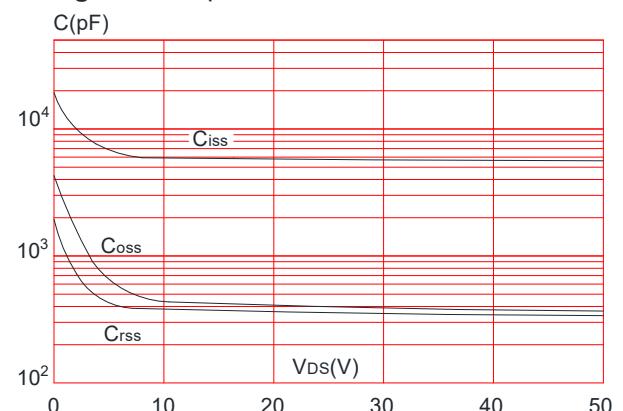


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

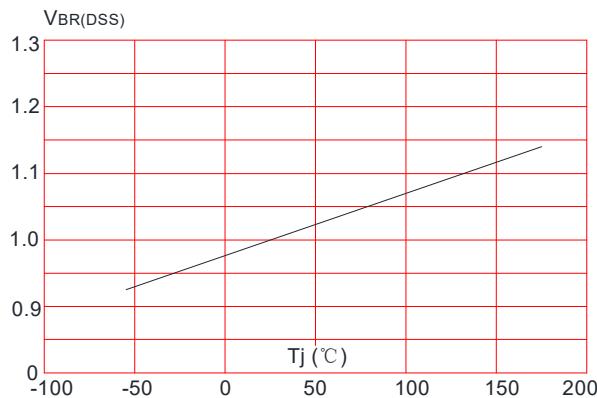


Figure 9: Maximum Safe Operating Area

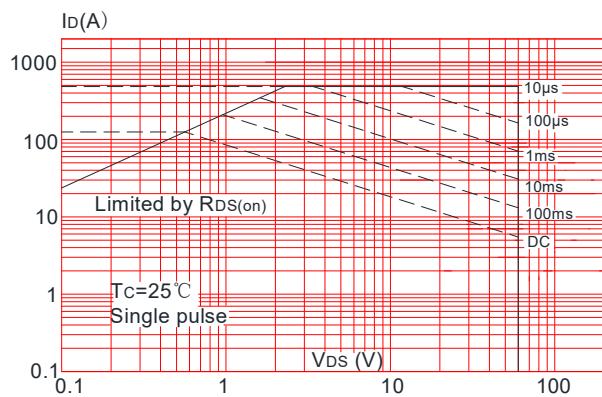


Figure 8: Normalized on Resistance vs. Junction Temperature

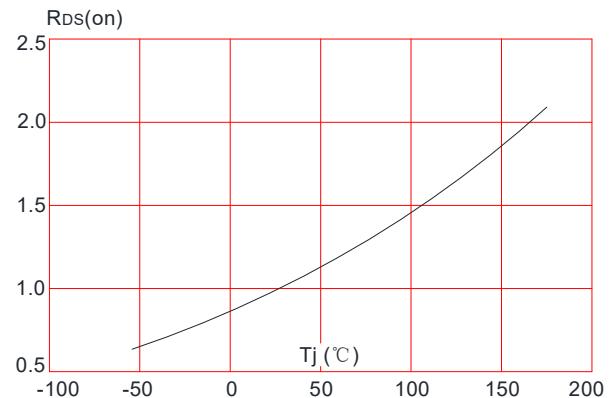


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

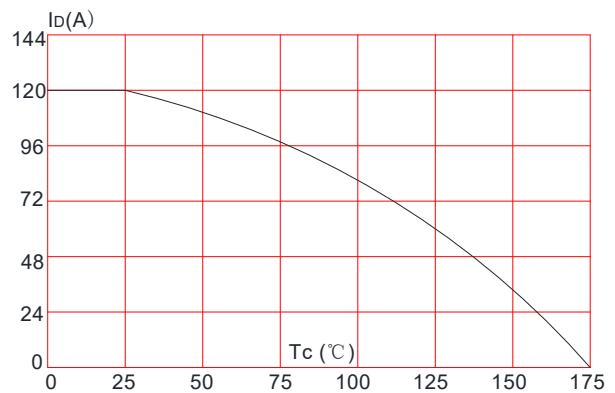
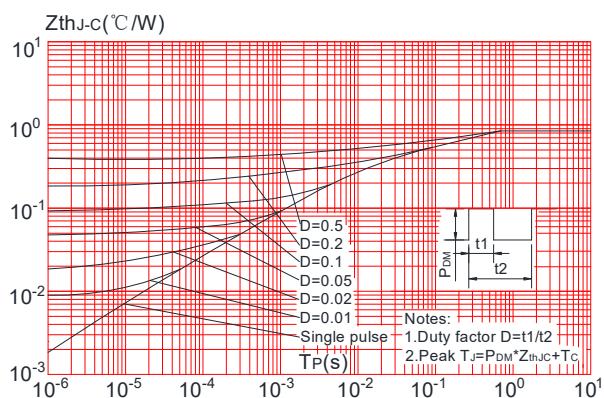


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case



Test Circuit



Figure 1: Gate Charge Test Circuit & Waveform

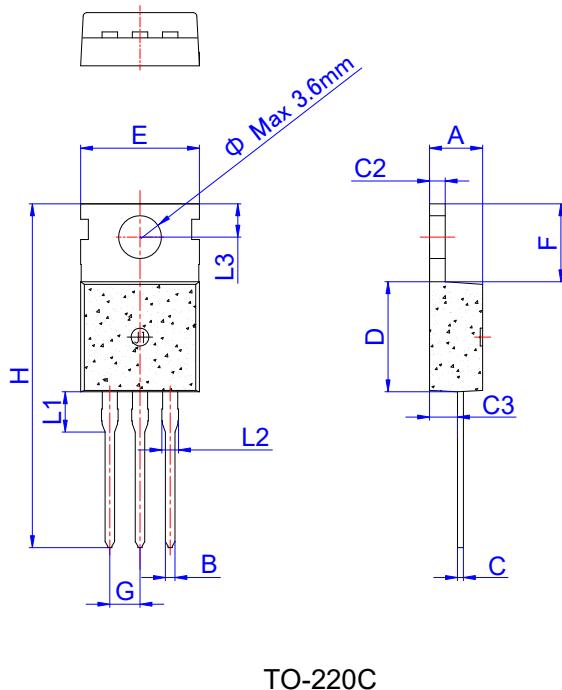


Figure 2: Resistive Switching Test Circuit & Waveforms



Figure 3: Unclamped Inductive Switching Test Circuit & Waveforms

Package Mechanical Data-TO-220C



| Ref. | Dimensions | | | | | |
|------|-------------|------|------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 | 0.173 | | 0.181 |
| B | 0.70 | | 0.90 | 0.028 | | 0.035 |
| C | 0.45 | | 0.60 | 0.018 | | 0.024 |
| C2 | 1.23 | | 1.32 | 0.048 | | 0.052 |
| C3 | 2.20 | | 2.60 | 0.087 | | 0.102 |
| D | 8.90 | | 9.90 | 0.350 | | 0.390 |
| E | 9.90 | | 10.3 | 0.390 | | 0.406 |
| F | 6.30 | | 6.90 | 0.248 | | 0.272 |
| G | | 2.54 | | | 0.1 | |
| H | 28.0 | | 29.8 | 1.102 | | 1.173 |
| L1 | | 3.39 | | | 0.133 | |
| L2 | 1.14 | | 1.70 | 0.045 | | 0.067 |
| L3 | 2.65 | | 2.95 | 0.104 | | 0.116 |
| Φ | | 3.6 | | | 0.142 | |

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